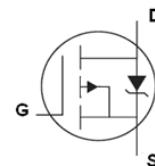
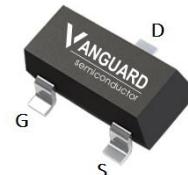


## Features

- P-Channel
- Enhancement mode
- Fast Switching
- Pb-free lead plating; RoHS compliant

$V_{DS}$	-30	V
$R_{DS(on),max}$ @ $V_{GS}=-10V$	52	mΩ
$R_{DS(on),max}$ @ $V_{GS}=-4.5V$	62	mΩ
$I_D$	-3.4	A

**SOT23**



Part ID	Package Type	Marking	Tape and reel information
VS3540AC	SOT23	VS01	3000pcs/reel

## Maximum ratings, at $T_j=25^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	-30	V
$V_{GS}$	Gate-Source voltage	$\pm 12$	V
$I_s$	Diode continuous forward current	$T_A=25^\circ\text{C}$	A
$I_D$	Continuous drain current @ $V_{GS}=-4.5V$	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	A
$I_{DM}$	Pulse drain current tested ①	$T_A=25^\circ\text{C}$	A
$P_D$	Maximum power dissipation	$T_A=25^\circ\text{C}$	W
$T_{STG} T_J$	Storage and operating temperature range	-55 to 150	°C

## Thermal Characteristics

$R_{eJL}$	Thermal Resistance, Junction-to-Lead	80	°C/W
$R_{eJA}$	Thermal Resistance, Junction-to-Ambient	125	°C/W

## Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-30	--	--	V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current( $T_j=25^\circ\text{C}$ )	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	$\mu\text{A}$
	Zero Gate Voltage Drain Current( $T_j=125^\circ\text{C}$ )	$V_{\text{DS}}=-30\text{V}, V_{\text{GS}}=0\text{V}$	--	--	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 12\text{V}, V_{\text{DS}}=0\text{V}$	--	--	$\pm 100$	nA
$V_{\text{GS(TH)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-0.5	--	-1.2	V
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance②	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-4\text{A}$	--	52	60	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-3\text{A}$	--	62	70	$\text{m}\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-2\text{A}$	--	81	105	$\text{m}\Omega$
<b>Dynamic Electrical Characteristics @ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	--	805	--	pF
$C_{\text{oss}}$	Output Capacitance		--	60	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	50	--	pF
$R_g$	Gate Resistance	$f=1\text{MHz}$	--	10	--	$\Omega$
$Q_g$	Total Gate Charge	$V_{\text{DS}}=-15\text{V}, I_{\text{D}}=-4\text{A}, V_{\text{GS}}=-4.5\text{V}$	--	10	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	2.3	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	4.2	--	nC
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=-15\text{V}, I_{\text{D}}=-4\text{A}, R_{\text{G}}=3\Omega, V_{\text{GS}}=-4.5\text{V}$	--	4	--	ns
$t_r$	Turn-on Rise Time		--	4	--	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	28	--	ns
$t_f$	Turn-Off Fall Time		--	4.6	--	ns
<b>Source- Drain Diode Characteristics@ <math>T_j = 25^\circ\text{C}</math> (unless otherwise stated)</b>						
$V_{\text{SD}}$	Forward on voltage	$I_{\text{SD}}=-3\text{A}, V_{\text{GS}}=0\text{V}$	--	-0.85	-1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$T_j=25^\circ\text{C}, I_{\text{sd}}=-3\text{A}, V_{\text{GS}}=0\text{V}, \frac{di}{dt}=-100\text{A}/\mu\text{s}$	--	12	--	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		--	3.6	--	nC

NOTE:

① Repetitive rating; pulse width limited by max junction temperature.

② Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .



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VS3540AC

-30V/-3.4A P-Channel Advanced Power MOSFET

## Typical Characteristics

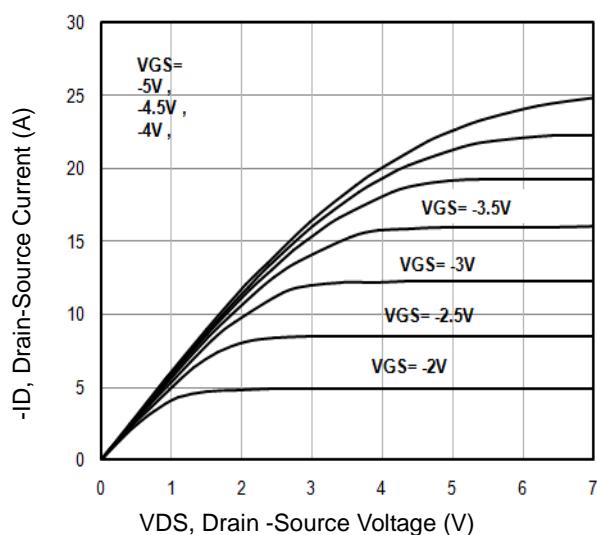


Fig1. Typical Output Characteristics

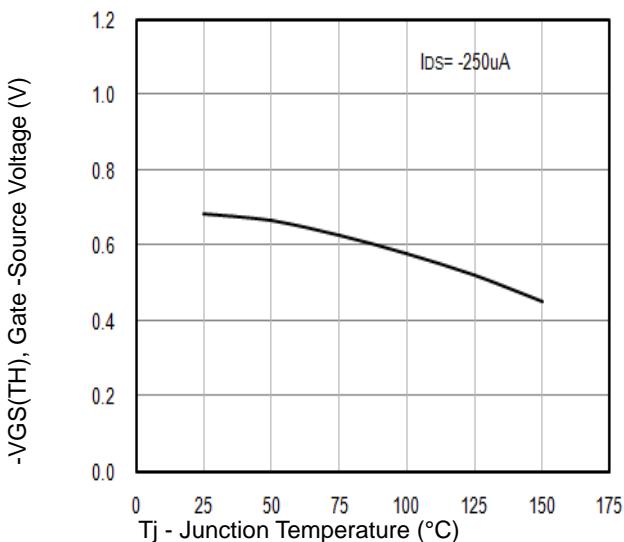


Fig2.  $V_{GS(TH)}$  Gate-Source Voltage Vs.  $T_j$

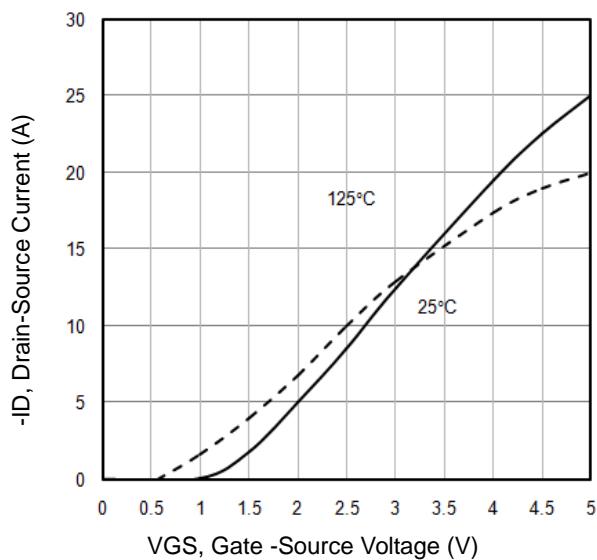


Fig3. Typical Transfer Characteristics

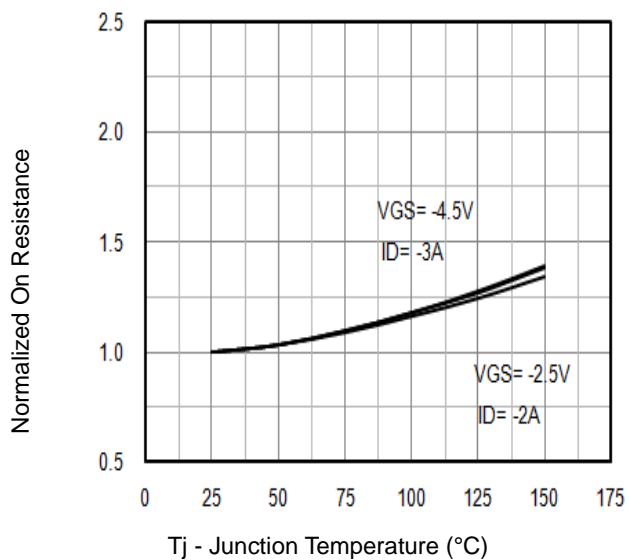


Fig4. Normalized On-Resistance Vs.  $T_j$

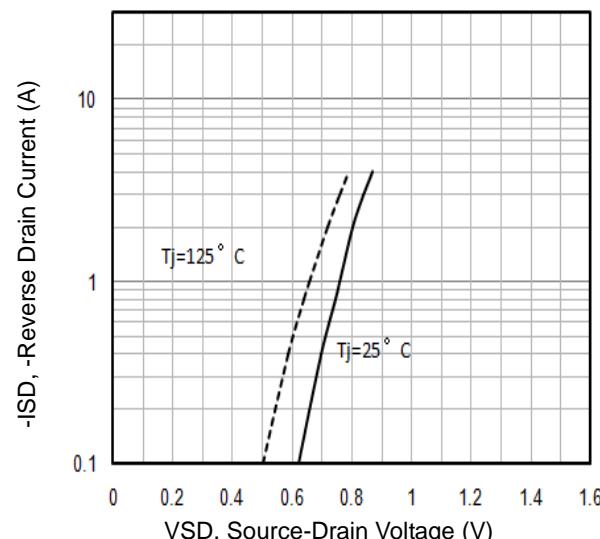


Fig5. Typical Source-Drain Diode Forward Voltage

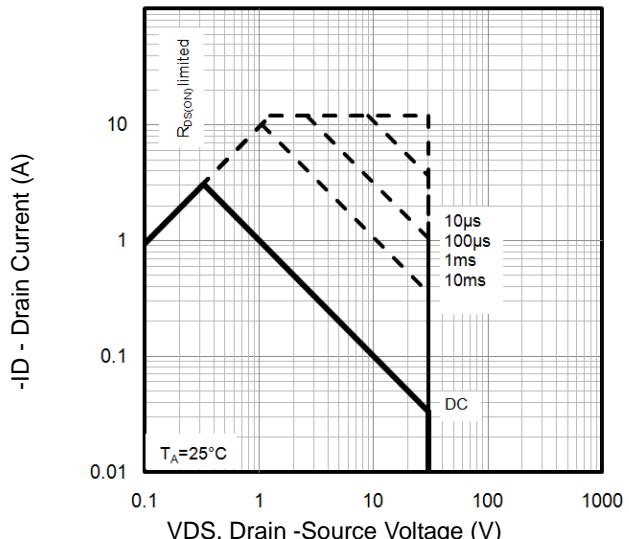


Fig6. Maximum Safe Operating Area

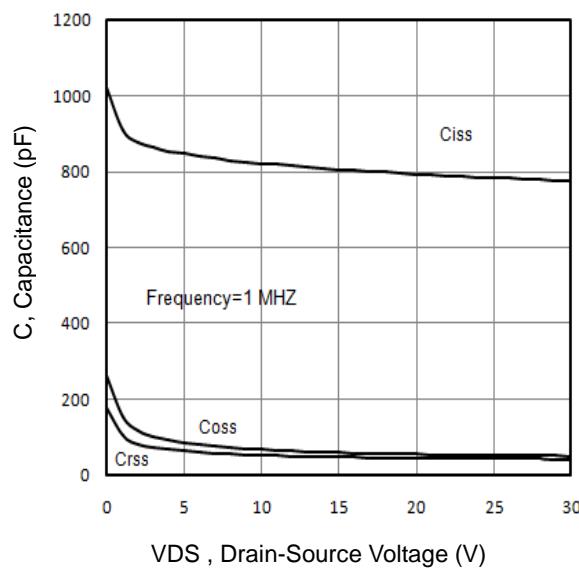


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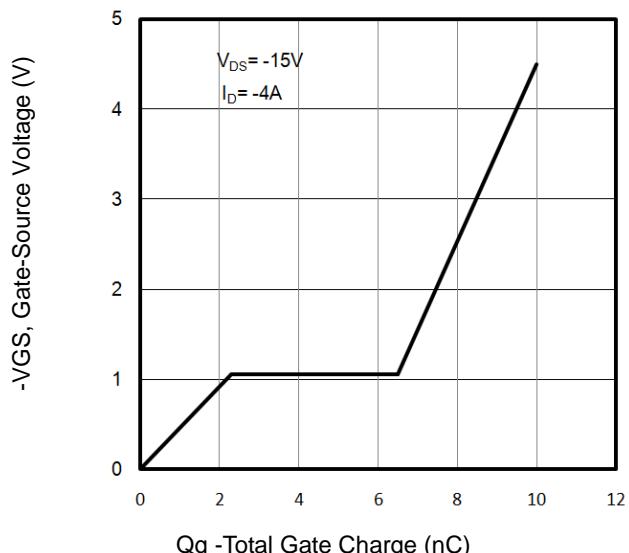
**VS3540AC**

**-30V/-3.4A P-Channel Advanced Power MOSFET**

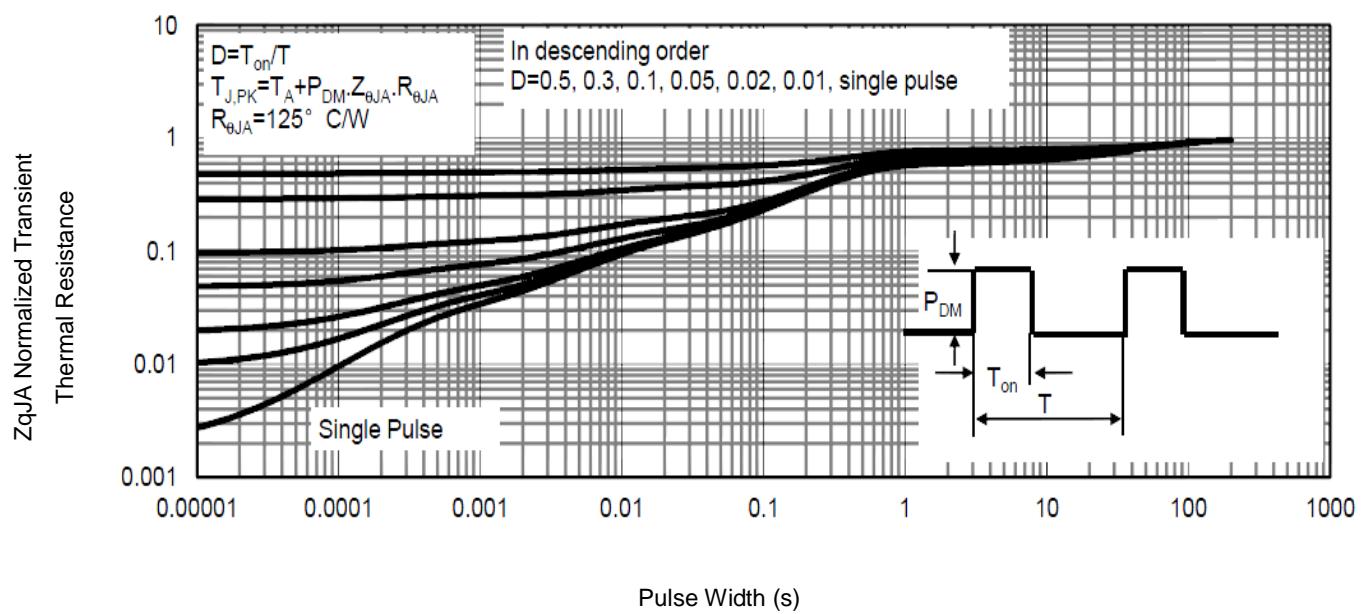
## Typical Characteristics



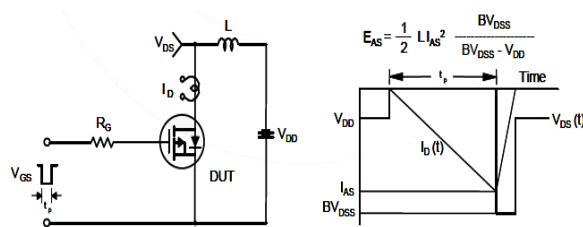
**Fig7.** Typical Capacitance Vs.Drain-Source Voltage



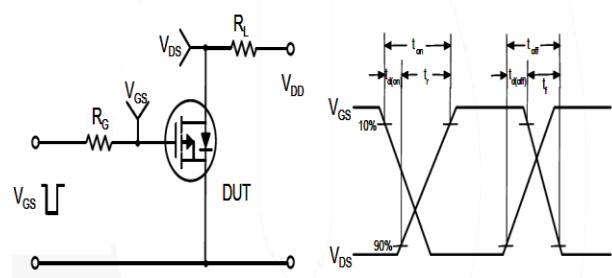
**Fig8.** Typical Gate Charge Vs.Gate-Source Voltage



**Fig9.** Normalized Maximum Transient Thermal Impedance

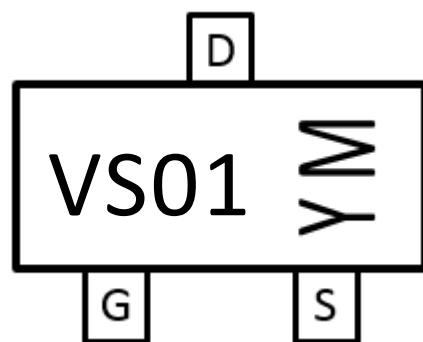


**Fig10.** Unclamped Inductive Test Circuit and waveforms



**Fig11.** Switching Time Test Circuit and waveforms

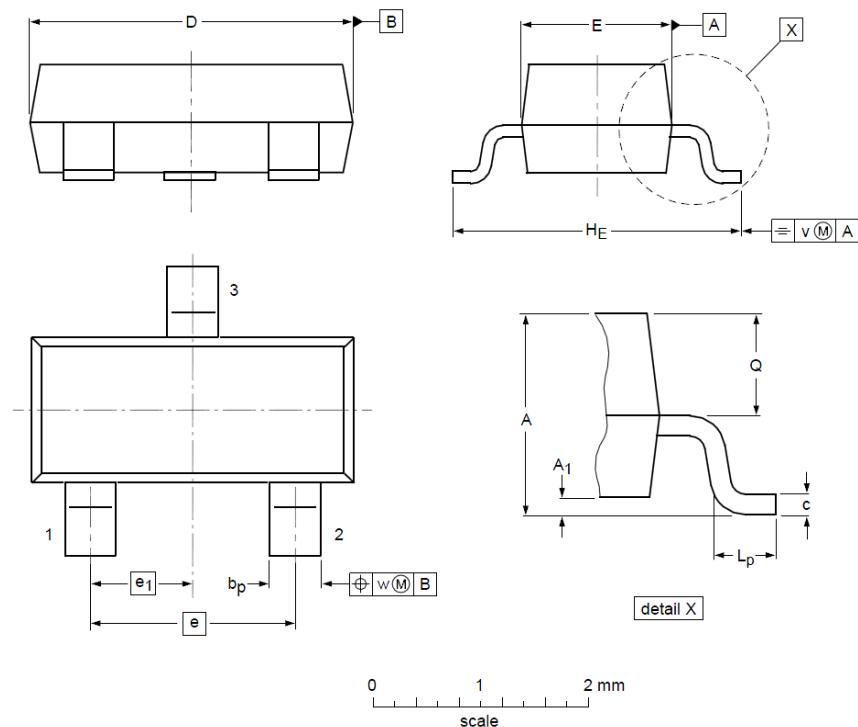
## Marking Information



VS01: Part Number

YM: Date Code, Y means assembly year (e.g. E=2017, F=2018, G=2019, H=2020, etc),  
M means assembly month (e.g. 9=September, O=October, N=November, D=December, etc)

## SOT23 Package Outline Data



Label	DIMENSIONS ( unit: mm )		
	Min	Typ	Max
<b>A</b>	0.90	1.03	1.10
<b>A<sub>1</sub></b>	0.01	0.05	0.10
<b>b<sub>p</sub></b>	0.38	0.42	0.48
<b>c</b>	0.09	0.13	0.15
<b>D</b>	2.80	2.92	3.00
<b>E</b>	1.20	1.33	1.40
<b>e</b>	--	1.90	--
<b>e<sub>1</sub></b>	--	0.95	--
<b>H<sub>E</sub></b>	2.10	2.40	2.50
<b>L<sub>p</sub></b>	0.40	0.50	0.60
<b>Q</b>	0.45	0.49	0.55
<b>v</b>	--	0.20	--
<b>w</b>	--	0.10	--

### Notes:

- Follow JEDEC TO-236, variation AB.
- Dimension "D" does NOT include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.25mm per side.
- Dimension "E" does NOT include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25mm per side.

## Customer Service

### Sales and Service:

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